

Strips modules assembly status

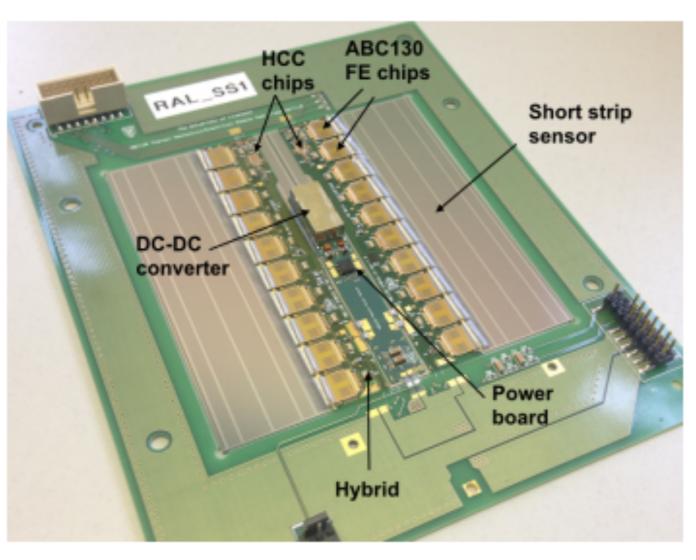
Alessandra Ciocio, William Evans, Thomas Johnson, Phathakone Sanethavong, Luise Poley, <u>Maosen Zhou</u>

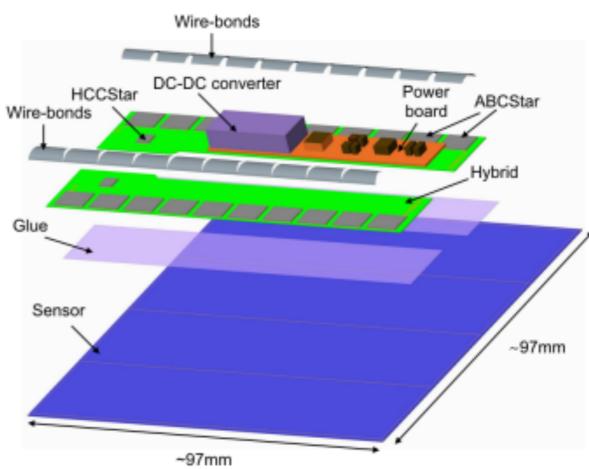
6/15/2018





Reminder



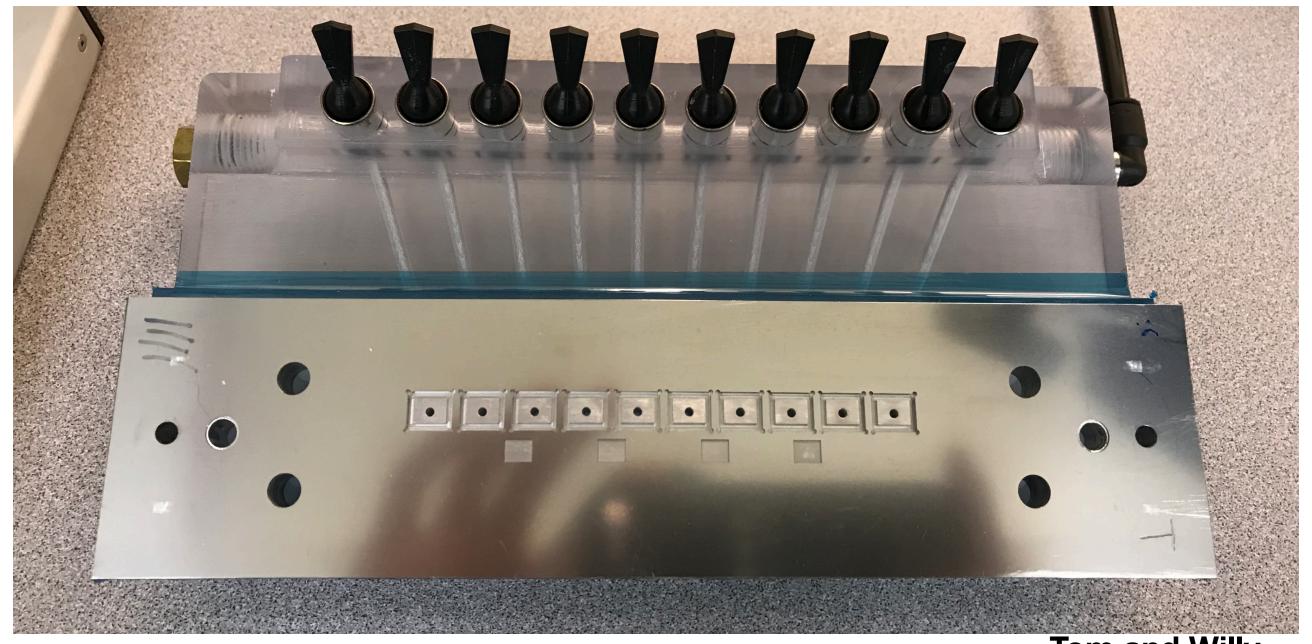


Overview

- Modules consist of new PB and v2 hybrids start from EL-03;
- 10 modules assembled, EL-02 and EL-03 have EBD;
- 5 modules with PB, and EL-07~EL-10 ready for PB;
- 2 sent to BNL for stave, one to Stony Brook for test stand setup.

Module ID	IV	1st hybrid	2nd hybrid	Hybrids	IV	Electrical test	PB mounted	IV	Electrical test	Shipped	Location	Shipped date	Comment
	bare sensor	mounted	mounted	bonded	w/o PB	w/o PB	and bonded	w/ PB	w/ PB				
LBL-EL-01											BNL	2018-3-6	
LBL-EL-02											Stony Brook	2018-6	Early break do
LBL-EL-03											LBL		Early break dov
LBL-EL-04											BNL	2018-6	
LBL-EL-05											LBL		
LBL-EL-06											LBL		
LBL-EL-07											LBL		
LBL-EL-08											LBL		
LBL-EL-09									Ohinnad		LBL		
LBL-EL-10									Shipped		LBL		
LBL-EL-11									Done		LBL		
LBL-EL-12									Not done		LBL		
LBL-EL-13									In progress		LBL		

Chip tray

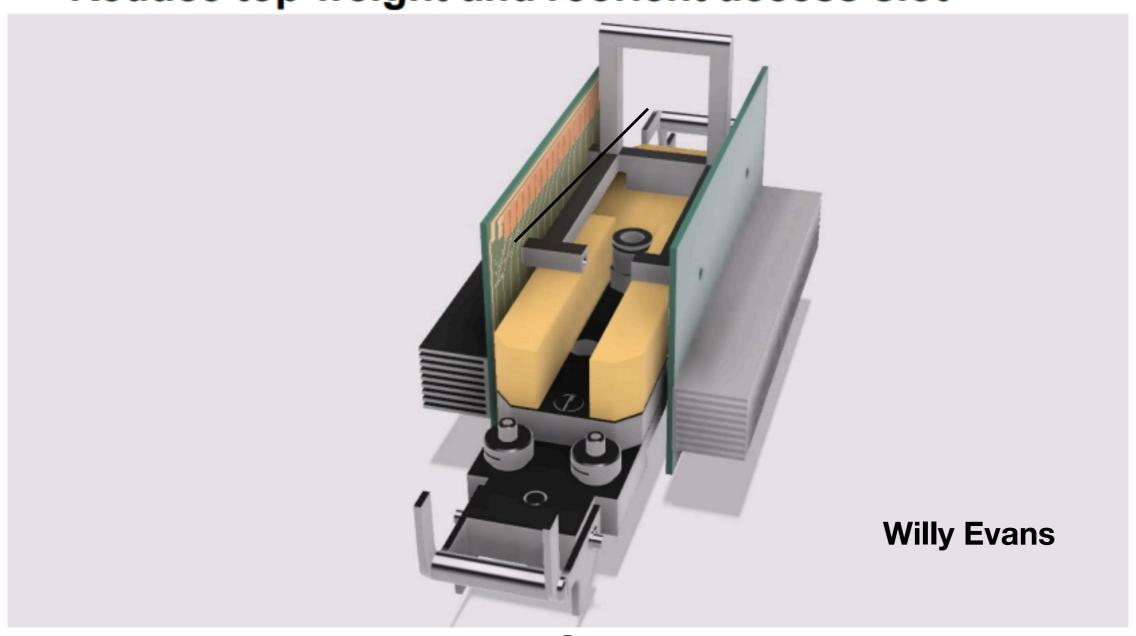


Tom and Willy

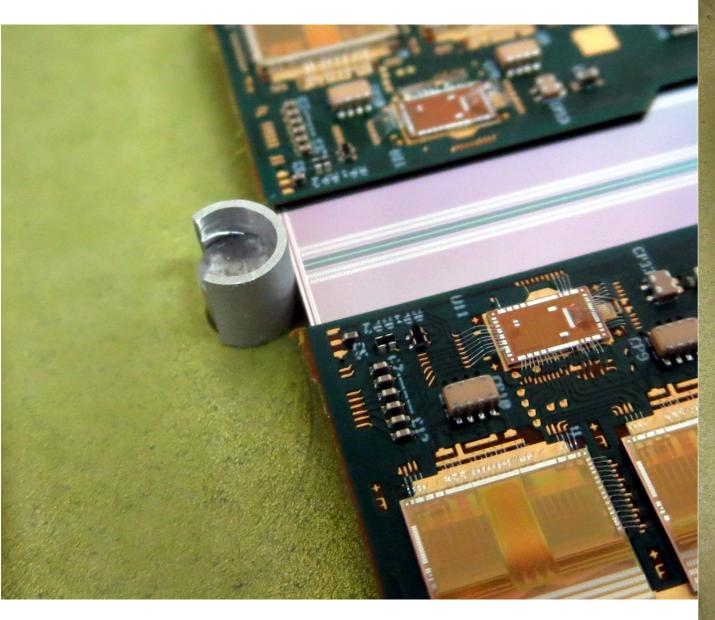
Current

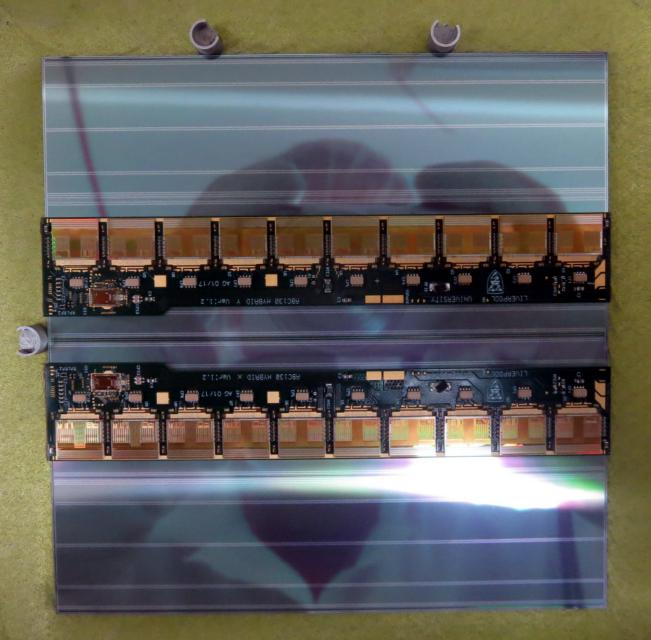
Future way for UV gluing

- Change to 5V parallel circuit design for LED's
- Replace vertical aluminum with PCB with heatsink
- Use 2 PCB boards for dual side illumination.
- Reduce top weight and reorient access slot

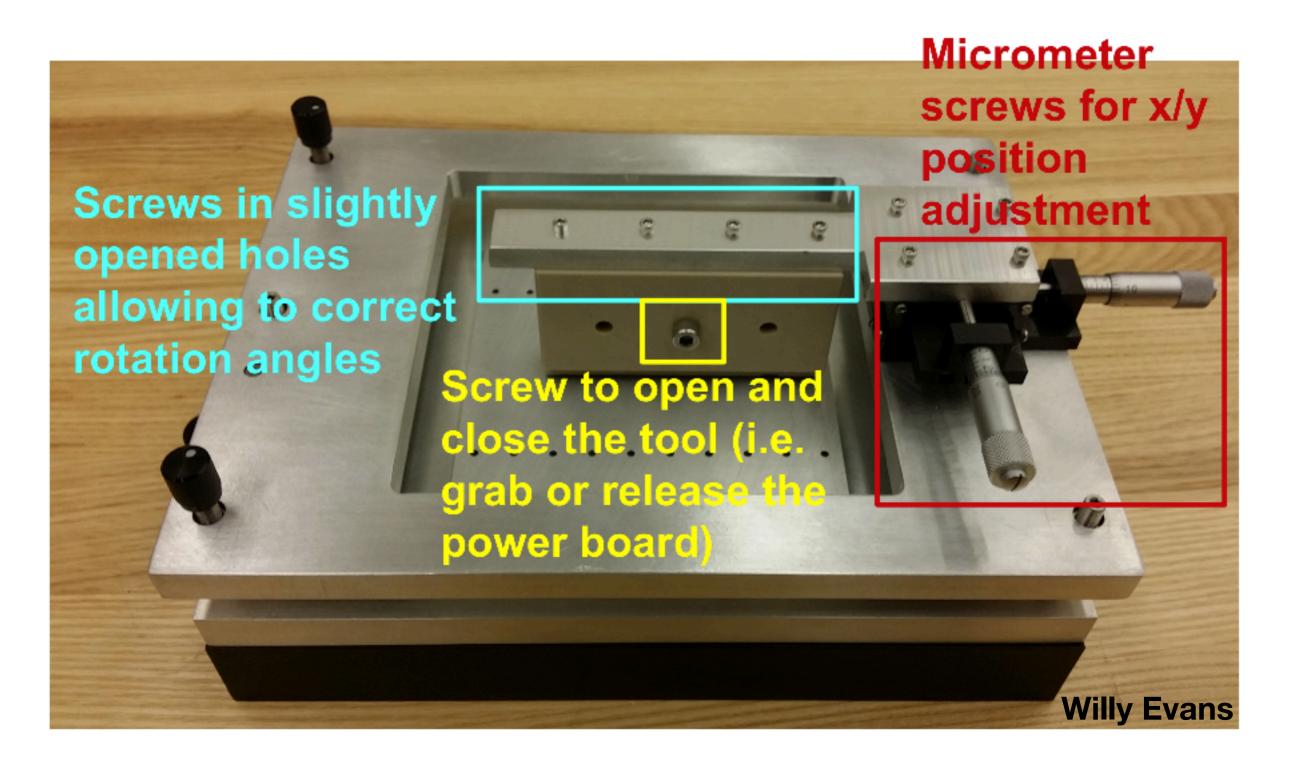


Sleeves for hybrids gluing

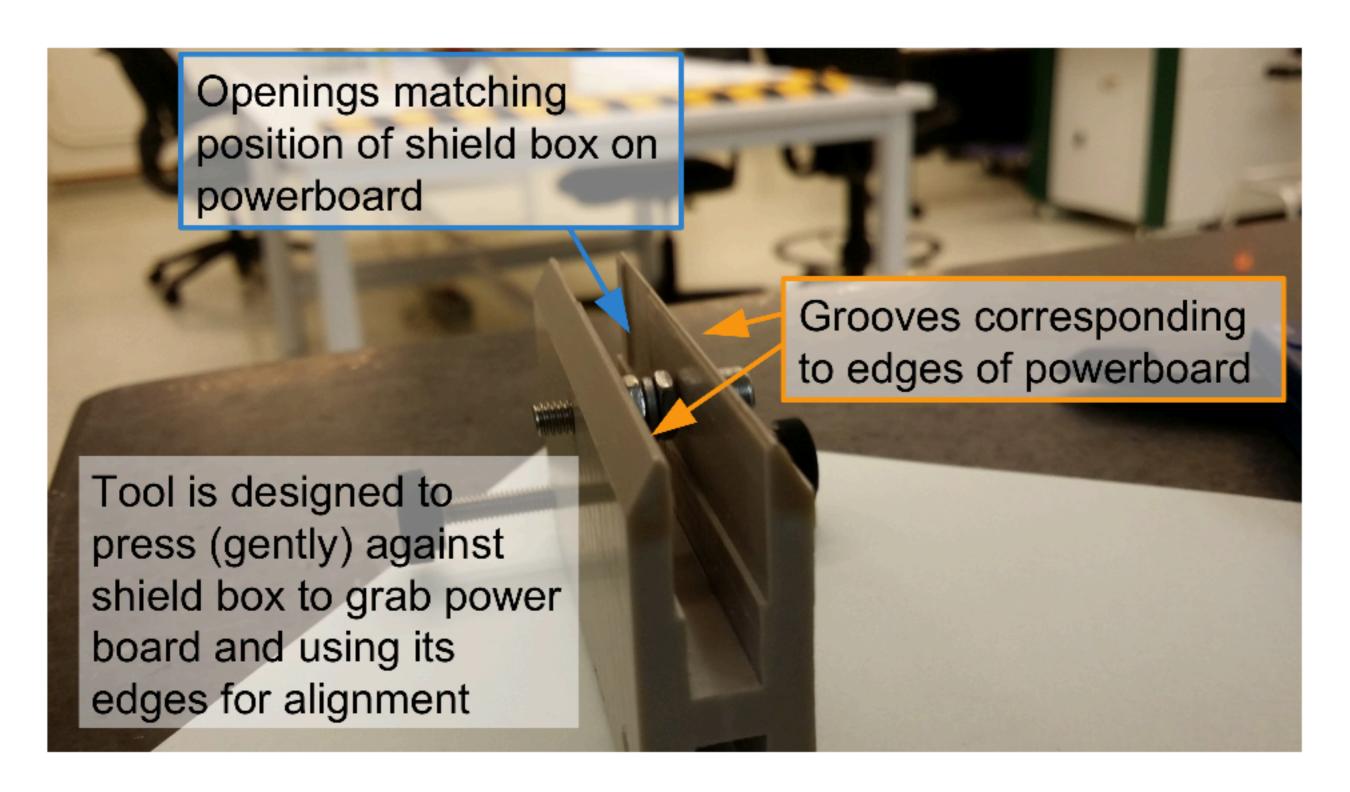




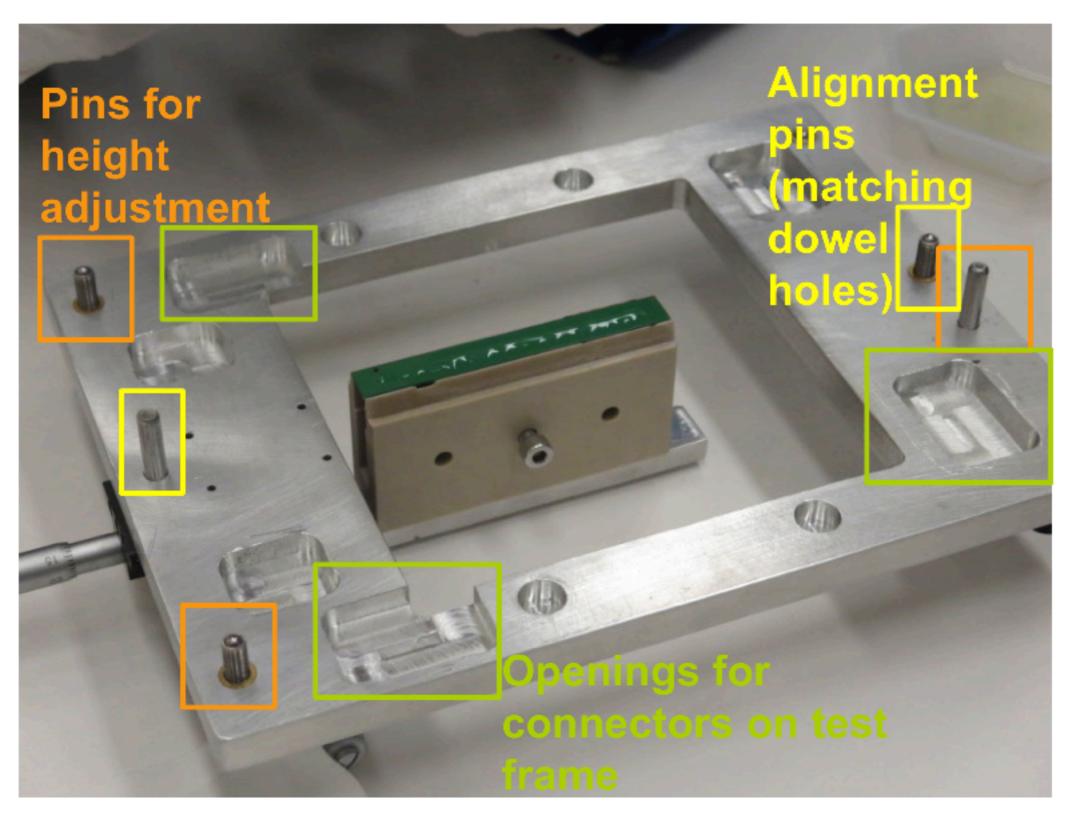
PB gluing tool - I



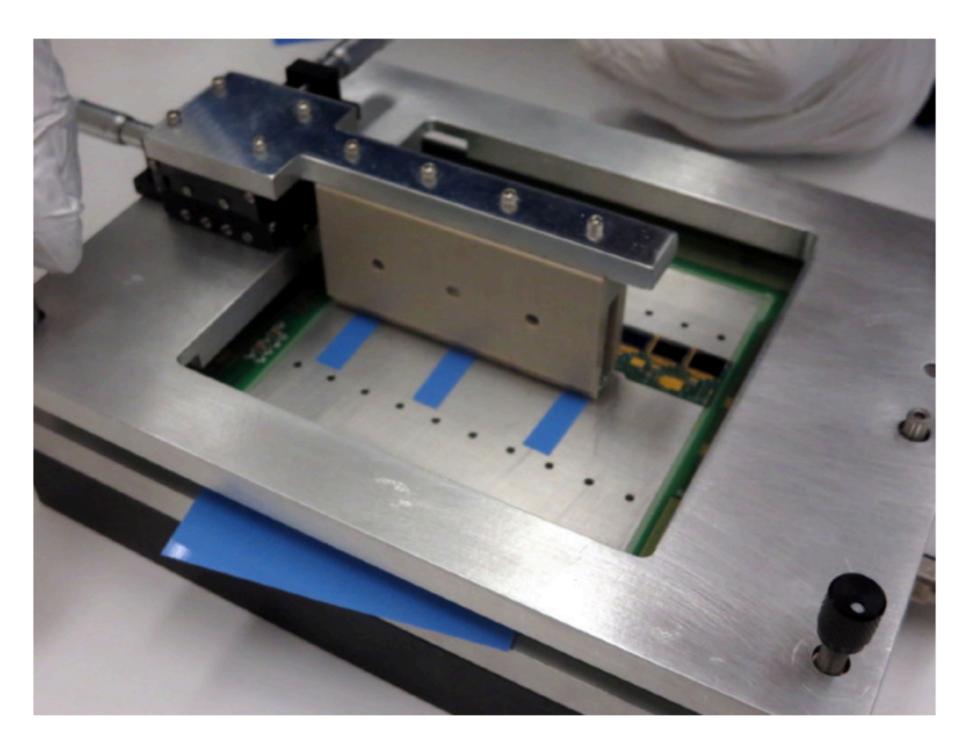
PB gluing tool - II



PB gluing tool - III



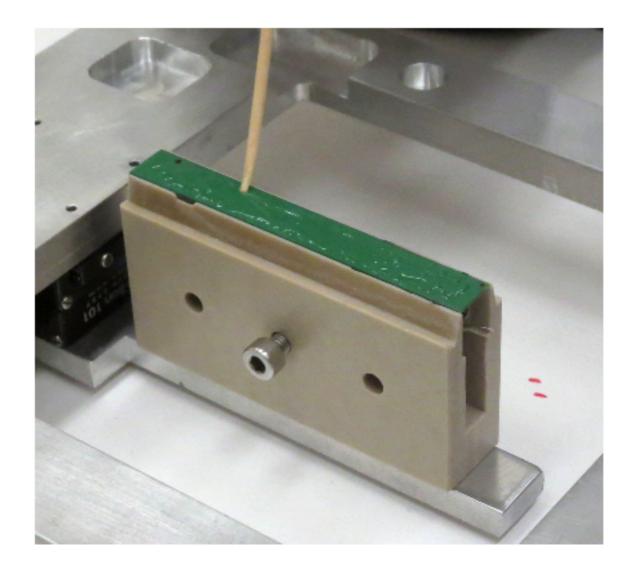
PB gluing tool - IV

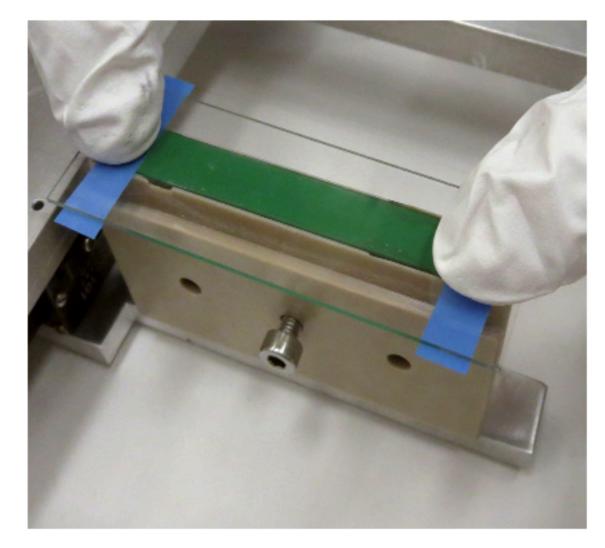


Fine adjustment using strips of shims in different positions of the gluing tool (check movement of shims under powerboard)

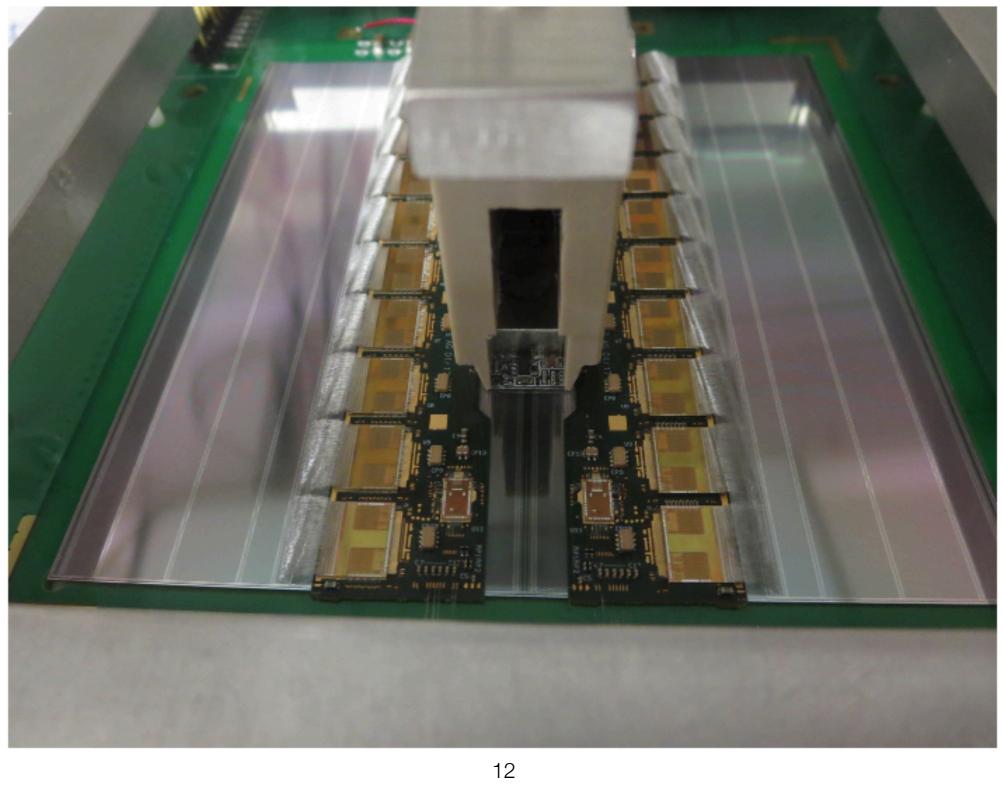
PB gluing tool - V

Plan for future: develop stencil for backside of powerboard for defined glue deposition, for now: test glue using shims and glass



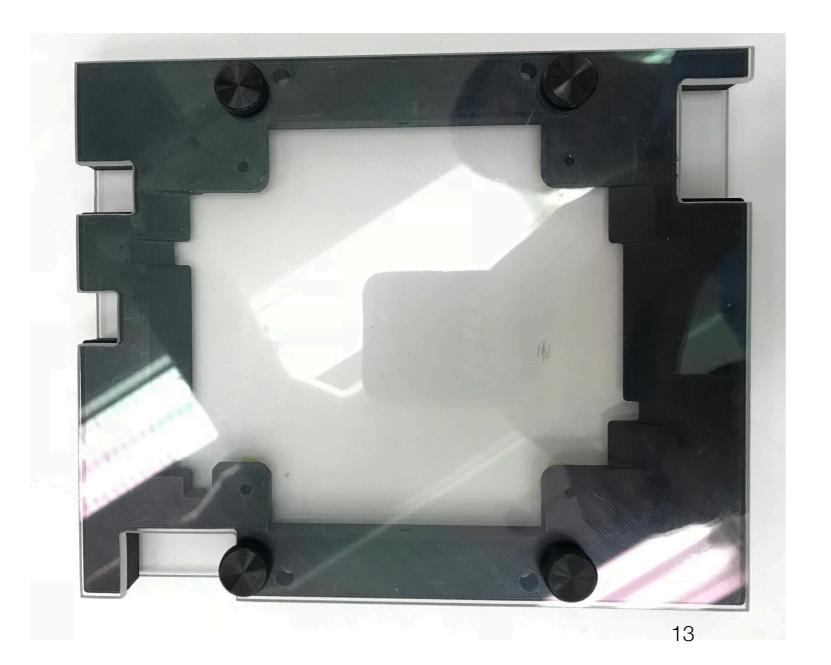


PB glued



Shipping box

- New modified 3D-printed ESD spacer;
- New screws and suction cups.



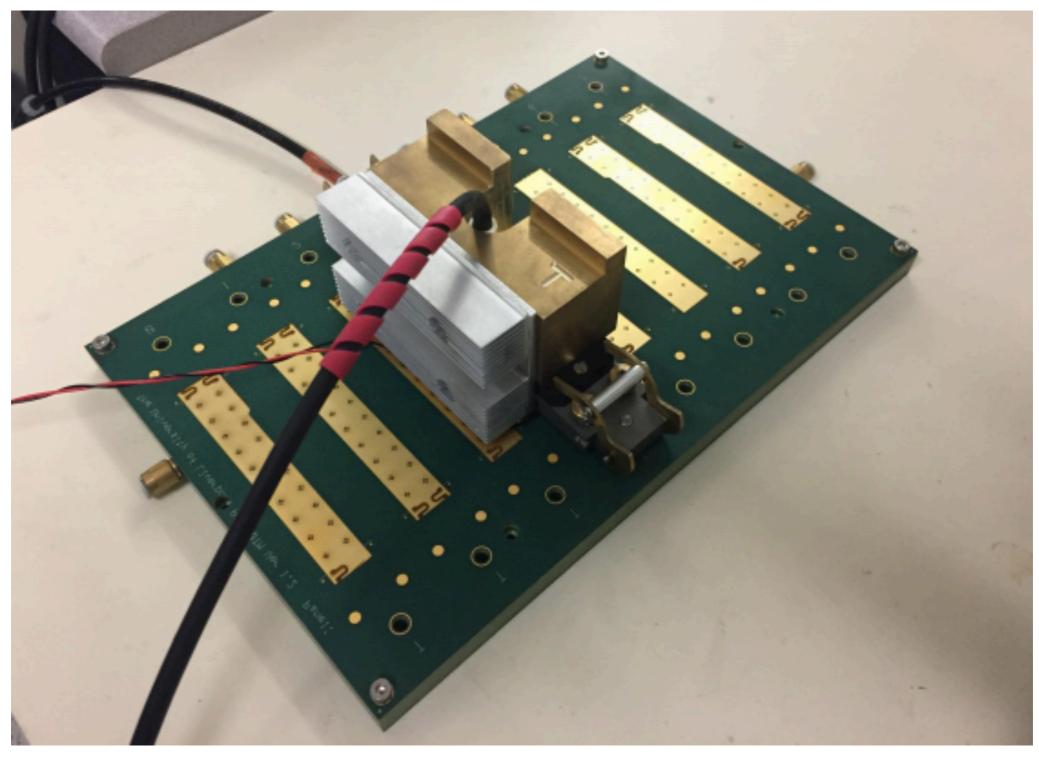


More..

- A lot of progress/improvements have been made, 3 more ABC130 modules to be assembled (if no problem happens);
- Other institutes expressed interests on new assembly toolings, tecs made drawings to circulate;
- Switched to use laser for metrology measurements.

Back up

Old way for UV gluing



Old way for placing PB Placing PB - I

